Nov 2021

Datasheet of PCBC Device

Printed Circuit Board with Ceramic Antenna

2400-2500 MHz

P/N: YSM3Y10

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Contents in this sheet are subject to change without prior notice.

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PCBC Antenna 3216 Size

1. Features

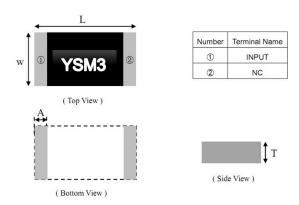
Antenna Frequency for 2400-2500 MHz

2. Applications

For Miniaturized Bluetooth System

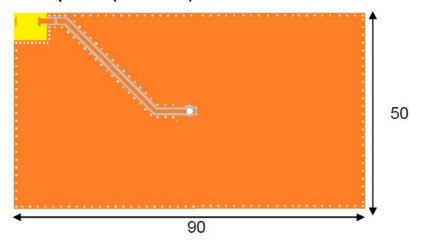
3. Shapes & Dimensions(Unit:mm)

1). Component (Unit: mm):

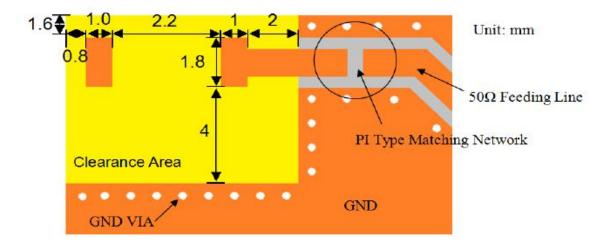


Symbols	L	W	Т	A
Dimensions	3.2+/-0.2	1.6+/-0.2	1.0+/-0.1	0.4+/-0.1

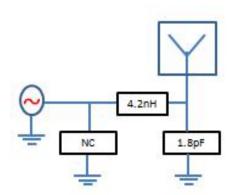
2). PCB Top View (Unit: mm):



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4. Evaluation Board and Matching Circuits

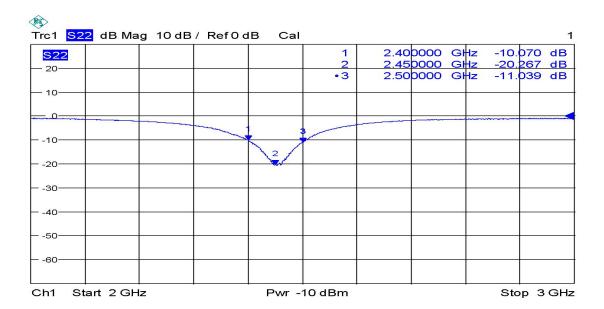


5. Electrical Characteristics

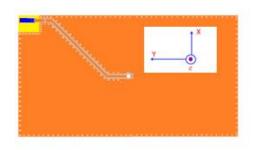
Part Number	YSM3Y10			
Central Frequency	2450 MHz			
Bandwidth	±50 (Min.)	MHz		
Return Loss	-10 (Max)			
Peak Gain	3.12	dBi		
Impedance	50	Ohm		
Polarization	Linear			
Azimuth Beamwidth	Omni-directional			

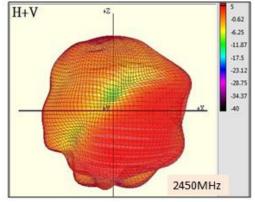
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6. Returm Loss



7. Radiation Pattern & Efficiency

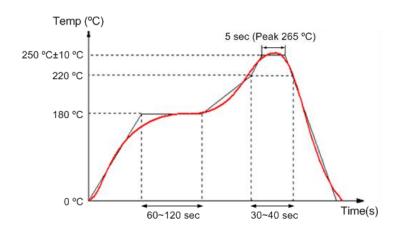




Frequency (MHz)	2400 2450		2500	
Efficiency (dB)	-2.01	-1.43	-1.74	
Efficiency (%)	63	72	67	
Gain (dBi)	3.01	3.12	2.73	

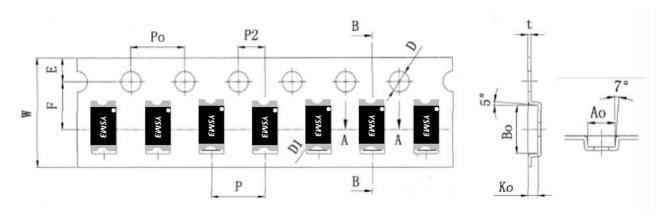
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8. Reflow Soldering Standard Condition



9. Packaging and Dimensions 3216 (3.2*1.6mm)

◆ Plastic Tape



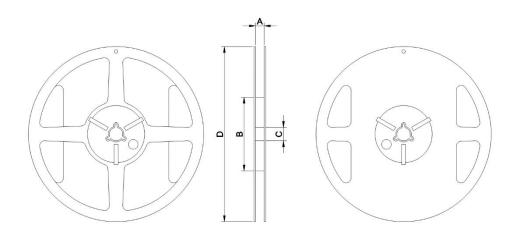
W	Ao	Во	Ko	Р	F	Е	D0	D1	Ро	P2	t
8.0	1.85	3.51	1.59	4.00	3.50	1.75	1.50	0.00	4.00	2.00	0.25
±0.30	±0.05	±0.10	±0.10	±0.05	±0.05	±0.10	±0.10	±0.10	±0.10	±0.05	±0.05

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♦ Remarks for Package

Reserve a length of 150~200mm for the trailer of the carrier and 250~300 mm for the leader of the carrier and further 250mm of cover tape at the leading part of the carrier.

◆ Reel (3000 pcs/Reel)



Tape	A (100 100)	D(100 100)	C(100 100)		Chip/Reel(pc	
Width(mm)	A(mm)	B(mm) C(mm)		(וווווו)	s)	
0	0.0.05	60.0	13.5±0.	170.0	2000	
8	9.0±0.5	60±2	5	178±2	3000	

♦ Storage Period

Oxidizable Material, 12 months in vacuum sealed bag, please repack within 168 hours by re-seal the package treatment after using.

Storage Temperature Range: <30 degree C, Humidity: <60%RH

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10. Dependability Test

Test item	Test condition / Test method	Specification		
Solderability *Solder bath temperature: 240±5°C #Immersion time: 2±0.5 sec Solder: Sn96.5Ag3.0Gu0.5 for lead-free.		At least 95% of a surface of each terminal electrode must be covered by fresh solder.		
Leaching (Resistance to dissolution of metallization) JIS C5101	*Solder bath temperature: 260±5°C *Leaching immersion time: 10±1 sec Solder: Sn96.5 Ag3.0 Gu0.5 for lead-free.	Loss of metallization on the edges of each electrode shall not exceed 25%.		
Resistance to soldering heat IEC 60068-2-58 GB/T2423.28	*Preheating temperature: 120~150°C, 1 minute. *Solder temperature: 260±5°C *Immersion time: 10±1 sec Solder: Sn96.5Ag3.0Gu0.5 for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature. Loss of metallization on the edges of each electrode shall not exceed 25%.		
Drop Test IEC 60068-2-32 GB/T2423.8 Customer's specification.	*Height: 50 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.		
*Frequency: 10Hz~55Hz~10Hz(1min) *Total amplitude: 1.5mm *Test times: 6hrs.(Two hrs each in three mutually perpendicular directions)		No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.		

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Adhesive Strength of Termination IEC60068-2-21 GB/T 2423.6	*Pressurizing force : 5N(≤0603); 10N(>0603) *Test time:10±1 sec	No remarkable damage or removal of the termination.
Bending test IEC 60068-2-21 GB/T 2423.29	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 2mm and then pressure shall be maintained for 10±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Temperature cycle IEC60068-2-14 GB/T 2423.22	30 minutes at-40°C±2°C. 10~15 minutes at room temperature. 30minutes at +85°C±2°C. 10~15 minutes at room temperature. Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
High temperature IEC 60068-2-2 GB/T2423.2	*Temperature: 85±2°C. *Test duration: 500+24/-0 hours. Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics.
Humidity (steady conditions) IEC60068-2-3 GB/T 2423.3	*Humidity: 85±5%R.H. *Temperature: 85±2°C. *Time: 500+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs × 200hrs measuring the first data then 300hrs data.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.
Low temperature IEC 60068-2-1 GB/T2423.1	*Temperature: -40±2°C. *Test duration: 500+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics at the room temperature.

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